

SEMITRANS® 10

IGBT M7 Modules SKM1800GB12M7ST

Features*

- V_{CE(sat)} with positive temperature coefficient
- High overload capability
- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
- Low loss high density IGBT's
- Fast & soft switching inverse CAL diodes
- UL recognized, file no. E63532

Typical Applications

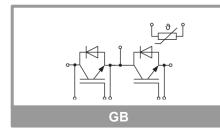
- Motor Drives
- UPS Systems
- Solar Inverters

Remarks

- Max. case temperature limited to T_c = T_s = 125 $^\circ\text{C}$
- Recommended T_{jop} = -40 ... +150 °C
- $I_{DC} \le 1000 \text{ A for } T_{Terminal} = 100 \text{ }^{\circ}\text{C}$

Absolute	e Maximum Rating	js		
Symbol	Conditions		Values	Unit
IGBT				
V _{CES}	Tj = 25 °C		1200	V
I _C	Tj = 175 °C	T _c = 25 °C	2475	A
	IJ = 175 C	T _c = 100 °C	1629	А
I _{Cnom}			1800	A
I _{CRM}			3600	А
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 V$ $V_{GE} \le 15 V$ $V_{CES} \le 1200 V$	T _j = 150 °C	8	μs
Tj			-40 175	°C
Inverse o	diode			
V _{RRM}	T _j = 25 °C		1200	V
l _F	T _j = 175 °C	T _c = 25 °C	2219	A
		T _c = 100 °C	1404	A
I _{FRM}			3600	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		7296	A
Tj			-40 175	°C
Module				
I _{t(RMS)}			1000	A
T _{stg}			-40 150	°C
Visol	AC sinus 50 Hz, t = 1 min		4000	V

Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
	I_{C} = 1800 A V _{GE} = 15 V chiplevel	T _j = 25 °C		1.55	1.88	V
		T _j = 150 °C		1.80	2.37	V
V _{CE0}	chiplevel	T _j = 25 °C		0.87	0.95	V
		T _j = 150 °C		0.76	0.91	V
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		0.38	0.52	mΩ
		T _j = 150 °C		0.58	0.81	mΩ
V _{GE(th)}	V _{CE} = 10V, I _C = 180	mA	5.4	6.0	6.6	V
I _{CES}	$V_{GE} = 0 V, V_{CE} = 12$	200 V, T _j = 25 °C			5.0	mA
Cies	V _{CE} = 10 V V _{GE} = 0 V	f = 1 MHz		360.0		nF
Coes		f = 1 MHz		10.97		nF
C _{res}		f = 1 MHz		3.84		nF
Q_{G}	V _{GE} = - 8 V / + 15 V			17310		nC
R _{Gint}	T _j = 25 °C			0.3		Ω
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		498		ns
tr	$I_{\rm C}$ = 1800 A	T _j = 150 °C		195		ns
Eon	V_{GE} = +15V/-15V R _{Gon} = 1 Ω	T _j = 150 °C		287		mJ
t _{d(off)}	$R_{Goff} = 0.5 \Omega$	T _j = 150 °C		694		ns
t _f	$di/dt_{on} = 9.2 \text{ kA/}\mu\text{s}$	T _j = 150 °C		117		ns
E _{off}	di/dt _{off} = 12.8 kA/µs dv/dt = 5406 V/µs L _S = 15 nH	T _j = 150 °C		232		mJ
R _{th(j-c)}	per IGBT				0.023	K/W
R _{th(c-s)}	per IGBT, (λ_{grease} = 0.81 W/(m*K))			0.012		K/W
R _{th(c-s)}	per IGBT, pre-appli material		0.006		K/W	





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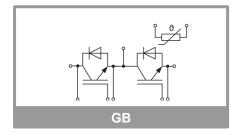
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Symbol	Conditions		min.	typ.	max.	Unit
Inverse				.76.		
inverse.	I _F = 1800 A	T = 25 °C		1.90	0.10	V
$V_F = V_{EC}$	$V_{GE} = 0 V$	T _j = 25 °C		1.80	2.13	v
	chiplevel	T _j = 150 °C		1.83	2.17	V
V _{F0}	chiplevel	T _j = 25 °C		1.19	1.40	V
		T _j = 150 °C		0.97	1.10	V
r _F	chiplevel	T _j = 25 °C		0.34	0.40	mΩ
		T _j = 150 °C		0.48	0.60	mΩ
I _{RRM}	$I_{F} = 1800 \text{ A}$ di/dt _{off} = 9.9 kA/µs $V_{GE} = -15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T _j = 150 °C		1067		Α
Qrr		T _j = 150 °C		338		μC
Err		T _j = 150 °C		140		mJ
R _{th(j-c)}	per diode				0.036	K/W
R _{th(c-s)}	per diode, (λ_{grease} = 0.81 W/(m*K))			0.017		K/W
R _{th(c-s)}	per diode, pre-applied phase change material			0.009		K/W
Module						
L _{CE}				10		nH
$R_{CC'+EE'}$	measured per switch, T _C = 25 °C			0.20		mΩ
R _{th(c-s)1}	calculated without thermal coupling $(\lambda_{grease}=0.81 \text{ W}/(m^*\text{K}))$			0.0019		K/W
R _{th(c-s)2}	including thermal coupling, T_s underneath module (λ_{grease} =0.81 W/(m*K))			0.003		K/W
R _{th(c-s)2}	including thermal coupling, T _s underneath module, pre-applied phase change material			0.002		K/W
Ms	to heat sink M5		4		6	Nm
M _t		terminal M8	8		10	Nm
	to	terminal M4	1.8		2.1	Nm
w					1250	g
Tempera	ature Sensor					
R ₁₀₀	T _c =100 °C (R ₂₅ =5 kΩ)			493 ± 5 %		Ω
B _{100/125}	$R_{(T)}=R_{100}exp[B_{100/125}(1/T-1/T_{100})]; T[K];$			3550 ±2 %		К



SKM1800GB<u>12M7</u>ST

T_i = 25 °C

T_i = 125 °C

T_j = 150 °C

3600

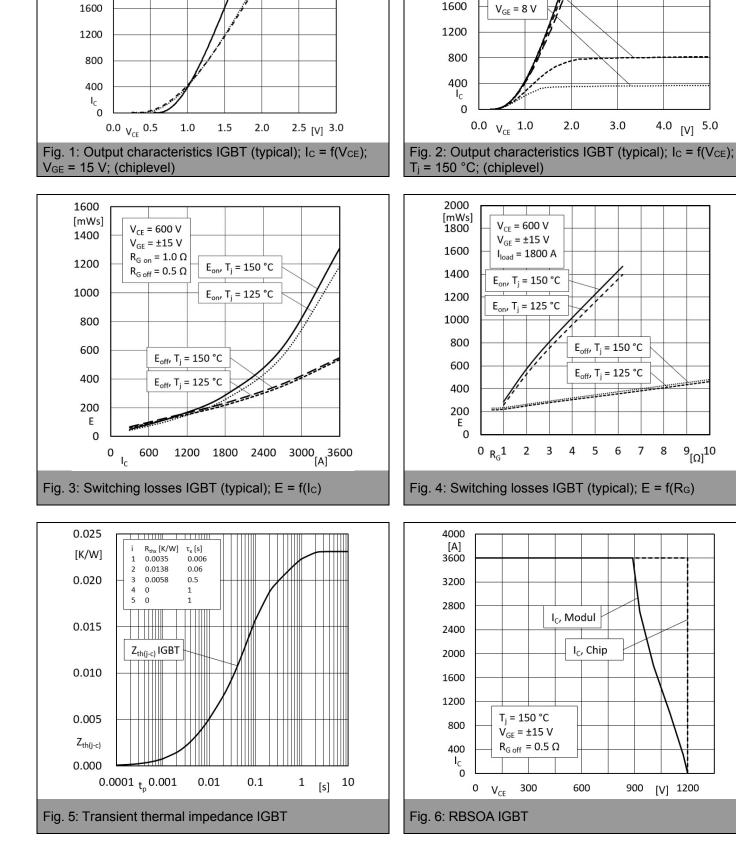
[A]

3200

2800

2400

2000



3600

[A]

3200

2800

2400

2000

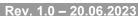
V_{GE} = 20 V

V_{GE} = 17 V

 V_{GE} = 15 V

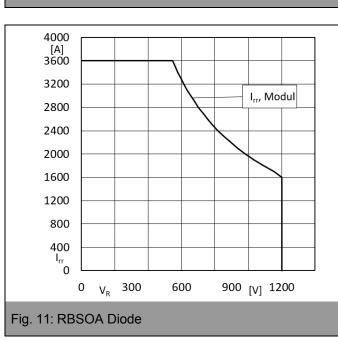
V_{GE} = 9 V

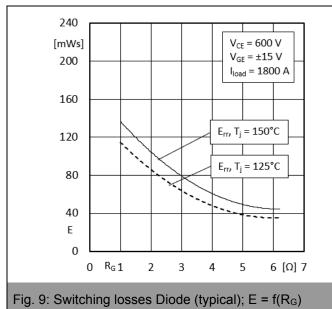




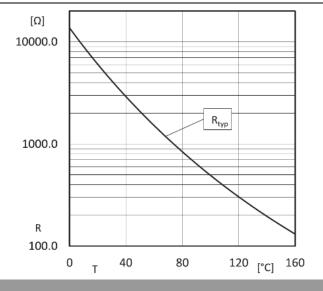
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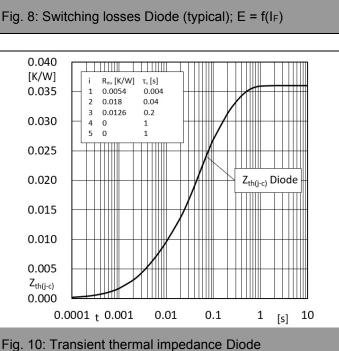
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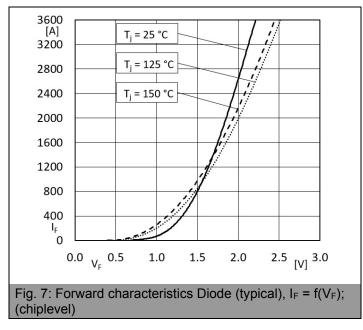




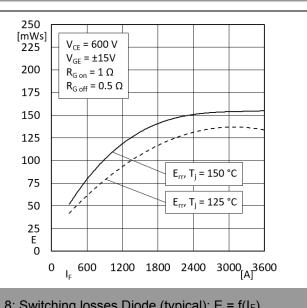


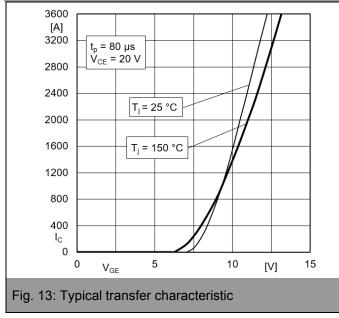


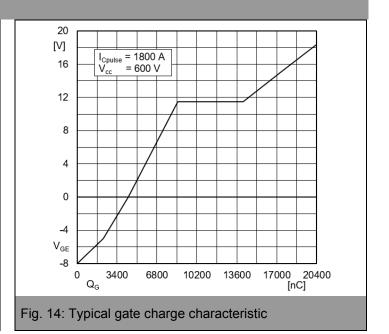


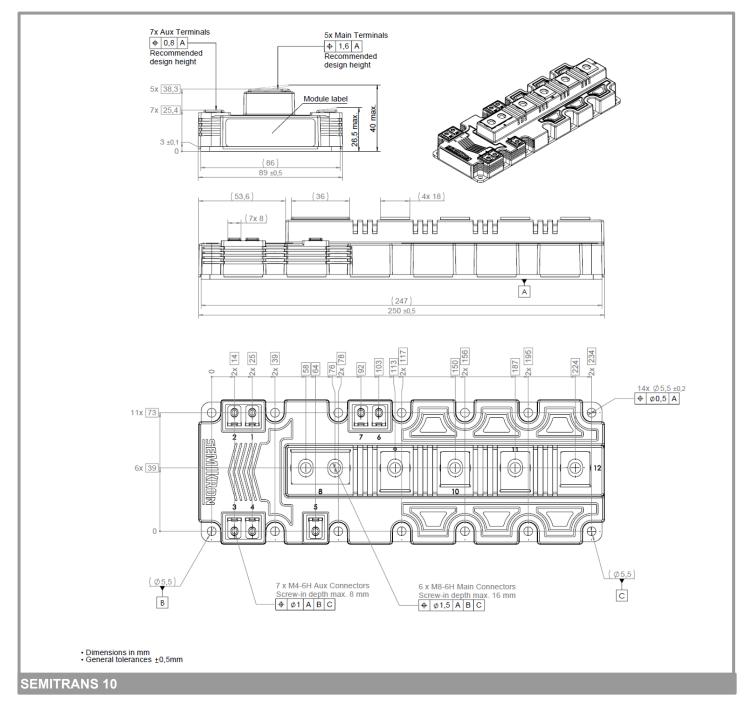


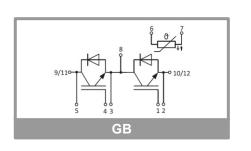
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This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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